

APGB0607W8G22F

0.65 x 0.65 x 0.25 mm Bi-Color Surface Mount LED

DESCRIPTIONS

- The source color devices are made with InGaN on Sapphire substrate Light Emitting Diode
- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode
- Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

FEATURES

- 0.65 mm x 0.65 mm SMD LED, 0.25 mm thickness
- Low power consumption
- Package: 4000 pcs / reel
- Moisture sensitivity level: 3
- Halogen-free
- RoHS compliant

APPLICATIONS

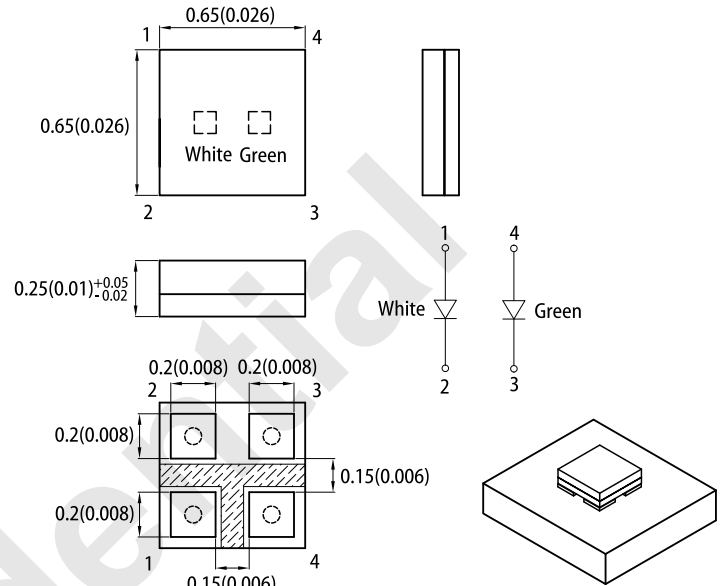
- Backlight
- Status indicator
- Home and smart appliances
- Wearable and portable devices
- Healthcare applications

ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices

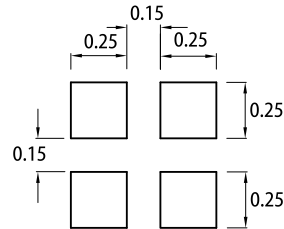


PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

(units : mm; tolerance : ± 0.1)



Mask open area ratio: 80%
Mask thickness: 80~100um

Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.1 (0.004") unless otherwise noted.
3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 5mA ^[2]		Viewing Angle ^[1]
			Min.	Typ.	2θ1/2
APGB0607W8G22F	White (InGaN)	Yellow Fluorescent	30	165	140°
	Green (InGaN)		50	200	

Notes:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity / luminous flux: $\pm 15\%$.
3. Luminous intensity value is traceable to CIE127-2007 standards.

ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C (WHITE)

Parameter	Symbol	Emitting Color	Value		Unit
			Typ.	Max.	
Chromaticity Coordinates x I _F = 5mA	x ^[1]	White	0.31	-	-
Chromaticity Coordinates y I _F = 5mA	y ^[1]	White	0.31	-	-
Capacitance	C	White	100	-	pF
Forward Voltage I _F = 5mA	V _F ^[2]	White	2.9	3.2	V
Reverse Current (V _R = 5V)	I _R	White	-	50	μA
Temperature Coefficient of x I _F = 5mA, -10°C ≤ T ≤ 85°C	TC _x	White	-0.18	-	10 ⁻³ /°C
Temperature Coefficient of y I _F = 5mA, -10°C ≤ T ≤ 85°C	TC _y	White	-0.19	-	10 ⁻³ /°C
Temperature Coefficient of V _F I _F = 5mA, -10°C ≤ T ≤ 85°C	TC _V	White	-3.0	-	mV/°C

Notes:

1. Measurement tolerance of the chromaticity coordinates is ±0.01.

2. Forward voltage: ±0.1V.

3. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C (GREEN)

Parameter	Symbol	Emitting Color	Value		Unit
			Typ.	Max.	
Wavelength at Peak Emission I _F = 5mA	λ _{peak}	Green	515	-	nm
Dominant Wavelength I _F = 5mA	λ _{dom} ^[1]	Green	525	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 5mA	Δλ	Green	30	-	nm
Capacitance	C	Green	45	-	pF
Forward Voltage I _F = 5mA	V _F ^[2]	Green	2.85	3.3	V
Reverse Current (V _R = 5V)	I _R	Green	-	50	μA
Temperature Coefficient of λ _{peak} I _F = 5mA, -10°C ≤ T ≤ 85°C	TC _{λpeak}	Green	0.05	-	nm/°C
Temperature Coefficient of λ _{dom} I _F = 5mA, -10°C ≤ T ≤ 85°C	TC _{λdom}	Green	0.03	-	nm/°C
Temperature Coefficient of V _F I _F = 5mA, -10°C ≤ T ≤ 85°C	TC _V	Green	-3.0	-	mV/°C

Notes:

1. The dominant wavelength (λ_d) above is the setup value of the sorting machine. (Tolerance λ_d: ±1nm.)

2. Forward voltage: ±0.1V.

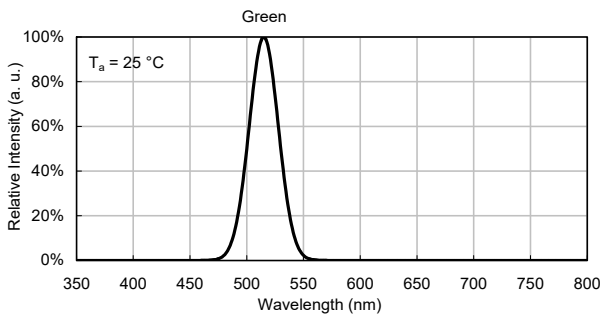
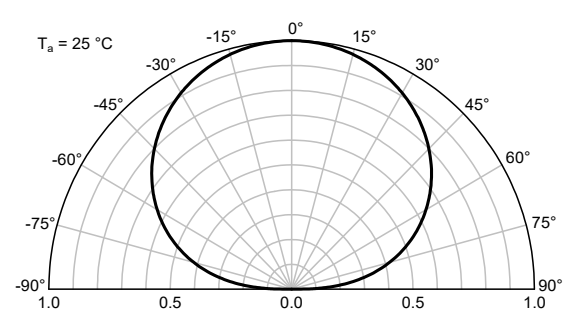
3. Wavelength value is traceable to CIE127-2007 standards.

4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at $T_A=25^{\circ}\text{C}$

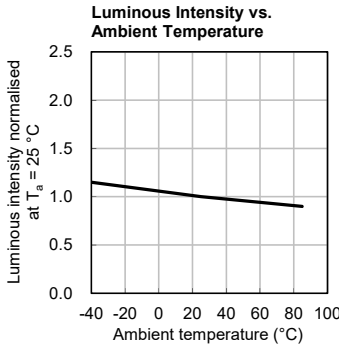
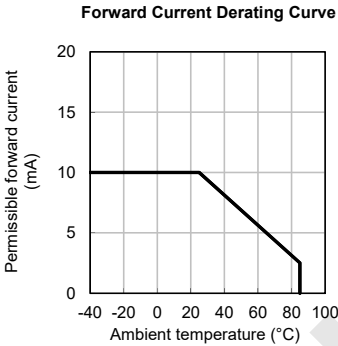
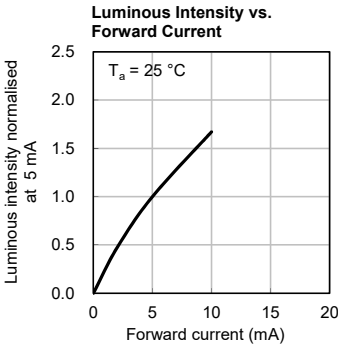
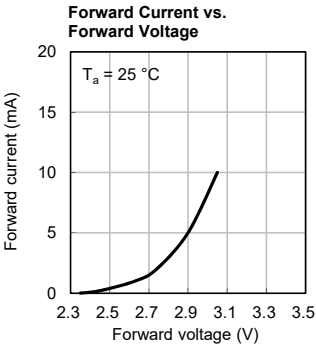
Parameter	Symbol	Value		Unit
		White	Green	
Power Dissipation	$P_D^{[1]}$	35		mW
Reverse Voltage	V_R	5	5	V
Junction Temperature	T_j	115	115	$^{\circ}\text{C}$
Operating Temperature	T_{op}	-40 to +85		$^{\circ}\text{C}$
Storage Temperature	T_{stg}	-40 to +100		$^{\circ}\text{C}$
DC Forward Current	$I_F^{[2]}$	10	10	mA
Peak Forward Current	$I_{FP}^{[3]}$	50	50	mA
Electrostatic Discharge Threshold (HBM)	-	250	450	V
Thermal Resistance (Junction / Ambient)	$R_{th JA}^{[4]}$	720	780	$^{\circ}\text{C/W}$
Thermal Resistance (Junction / Solder point)	$R_{th JS}^{[4]}$	580	650	$^{\circ}\text{C/W}$

Notes:
 1. Within 35mW when multiple chips are lightened
 2. The maximum ratings are valid for the case of lighting a single chip
 When two chips are lit at the same time, each chip should be driven at a current lower than 50% of the absolute maximum ratings
 3. Duty Cycle $\leq 1/20$, Pulse Width = 1ms.
 4. $R_{th JA}$, $R_{th JS}$ Results from mounting on PC board FR4 (pad size $\geq 16\text{ mm}^2$ per pad).
 5. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

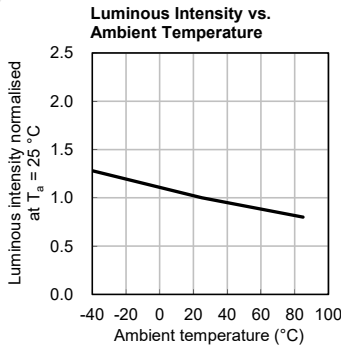
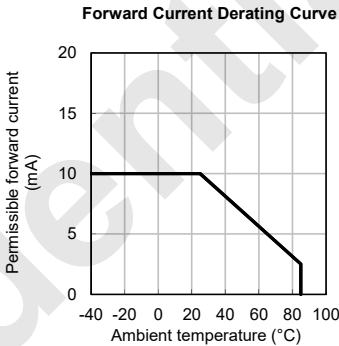
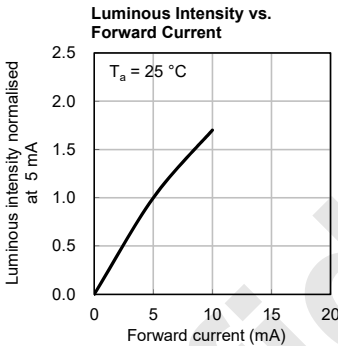
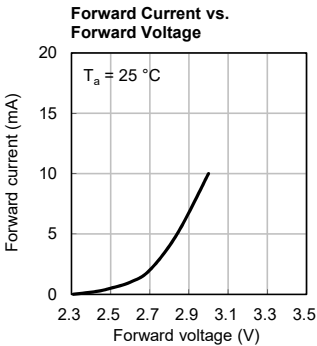
TECHNICAL DATA**RELATIVE INTENSITY vs. WAVELENGTH****SPATIAL DISTRIBUTION**

TECHNICAL DATA

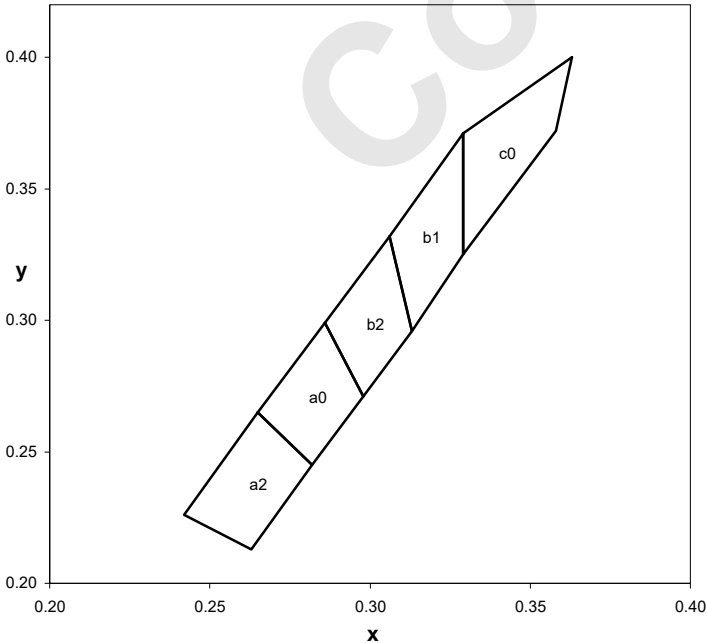
WHITE



GREEN



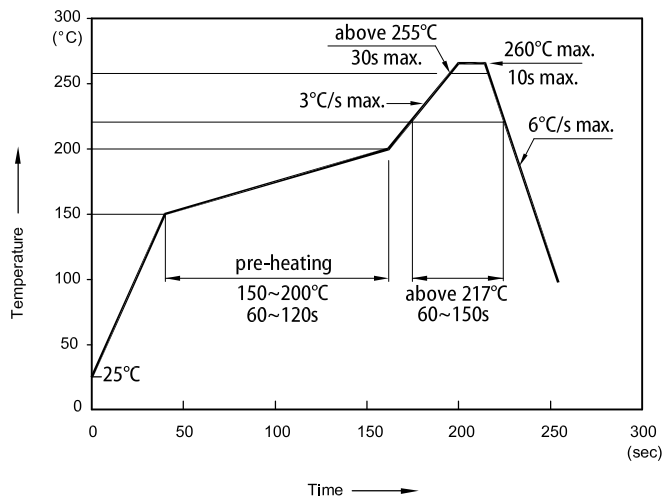
CIE CHROMATICITY DIAGRAM



x		y	x		y
a2	0.263	0.213	a0	0.282	0.245
	0.282	0.245		0.298	0.271
	0.265	0.265		0.286	0.299
	0.242	0.226		0.265	0.265
b2	0.298	0.271	b1	0.313	0.296
	0.313	0.296		0.329	0.325
	0.306	0.332		0.329	0.371
	0.286	0.299		0.306	0.332
c0	0.329	0.325			
	0.358	0.372			
	0.363	0.400			
	0.329	0.371			

Notes:
Shipment may contain more than one chromaticity regions.
Orders for single chromaticity region are generally not accepted.
Measurement tolerance of the chromaticity coordinates is ± 0.01 .

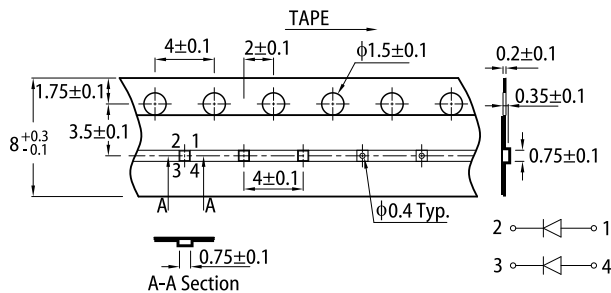
REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS



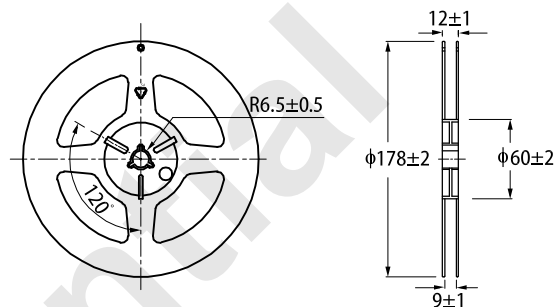
Notes:

1. Don't cause stress to the LEDs while it is exposed to high temperature.
2. The maximum number of reflow soldering passes is 2 times.
3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

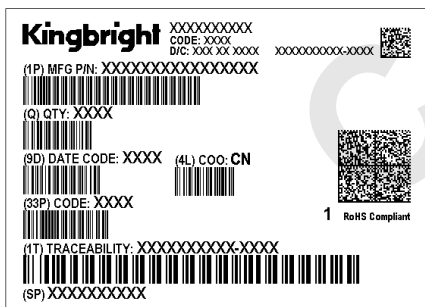
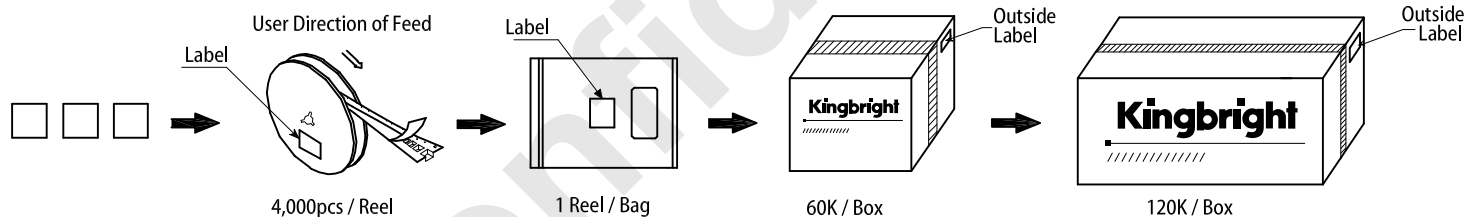
TAPE SPECIFICATIONS (units : mm)



REEL DIMENSION (units : mm)



PACKING & LABEL SPECIFICATIONS



PRECAUTIONARY NOTES

1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
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